	CONNECTING CS INDUSTRIES® MALETING CS INDUSTRIES® MALETIAL COMP	PC, Bannockb	ourn, Illinois. A	All rights reserved u ntions.	nder both	This docume level parts, t	ent is a declarat	tion of th encompa	e substances asses all low	within the er level mat	manufactur erials for wh	er listed ite hich the m	em. Note: if anufacturer	the item is an as has engineering	ssembly with lowe responsibility.
1752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					als and Mfg Information					
Supplie	r Information														
Company name* Compa				ompany unique ID			Unique ID Authority					Response Date*			
onsemi												2025-05-15			
Contact N	lame		Title - Contact]	Phone - Contact*					Email - Contact*			
Product-	Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
uthorize	ed Representative*		Title - Representative]	Phone - Representative*				Email - Representative*				
Product-	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Item FNA230						Effective Date	te Version Manufacturing Site		ring Site	v	Veight*	UOM	Unit Type	
							2025-05-15 CPA			4	9614.715	mg	Each		
/Ianufa	cturing Proccess Informa	tion					-								
	Terminal Plating / Grid Array Material		Ferminal Base Alloy J-STD-020 M		J-STD-020 MSI	L Rating	Peak Process Body Temperat		ure Max Time at Peak Tempe		Temperatu	ire Numbe	er of Reflow Cy	cles	
	Matte Tin (Sn) - annealed		U Alloy NA			0 C		30 se		second	ls 3				
omments	5														
or more	information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		mium (Cr6+), Polybrominated Biphenyls (Pl		dmium and quantity limit of 0.1% by mass (10 minated Diphenyl Ethers (PBDE), and Bis(2-et					
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in ifies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of				
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted				
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).						
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.									
Supplier Digital Signature	astislav Drska	Le							

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	104.6	mg	Supplier	Silicon (Si)	7440-21-3		104.6	mg
Die Attach	195.0	mg	Supplier	Silver (Ag)	7440-22-4		5.85	mg
			Supplier	Tin (Sn)	7440-31-5		188.175	mg
			Supplier	Copper (Cu)	7440-50-8		0.975	mg
Die Attach Epoxy	1.85	mg	Supplier	Silver (Ag)	7440-22-4		1.702	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.148	mg
Die Attach Solder	1.7	mg	Supplier	Silver (Ag)	7440-22-4		0.0425	mg
			А	Lead (Pb)	7439-92-1	7a	1.5725	mg
			Supplier	Tin (Sn)	7440-31-5		0.085	mg
Heat Sink	6642.0	mg	Supplier	Aluminum (Al)	7429-90-5		6642	mg
Lead Frame	11022.5	mg	Supplier	Iron (Fe)	7439-89-6		16.5338	mg
			Supplier	Copper (Cu)	7440-50-8		11000.4551	mg
			Supplier	Phosphorus (P)	7723-14-0		5.5103	mg
Mold Compound-Black	31430.0	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		1571.5	mg
			Supplier	Carbon Black (C)	1333-86-4		314.3	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		27972.6992	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1571.5	mg
Plating	106.6	mg	Supplier	Tin (Sn)	7440-31-5		106.6	mg
Thermistor	10.0	mg	Supplier	Silver (Ag)	7440-22-4		0.8	mg
			Supplier	Tin (Sn)	7440-31-5		0.17	mg
			Supplier	Nickel Oxide (NiO)	1313-99-1		2.6	mg
			Supplier	Palladium (Pd)	7440-05-3		0.35	mg
			В	Nickel (Ni)	7440-02-0		0.08	mg
			Supplier	Cobalt Oxide (Co3O4)	1308-06-1		1.7	mg
			Supplier	Manganese Tetraoxide (Mn3O4)	1317-35-7		4.3	mg
Vire Bond - Al	100.0	mg	Supplier	Aluminum (Al)	7429-90-5		100	mg
Wire Bond - Cu	0.463	i3 mg	Supplier	Palladium (Pd)	7440-05-3		0.0093	mg
			Supplier	Copper (Cu)	7440-50-8		0.4537	mg

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).